



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BV _{DSS} | R _{DS(ON)} Max | I _D Max T _A = +25°C |
|-------------------|-------------------------------|--|
| 30V | 1.5Ω @ V _{GS} = 4.5V | 0.41A |
| | 2.0Ω @ V _{GS} = 2.5V | 0.36A |
| | 3.0Ω @ V _{GS} = 1.8V | 0.29A |
| | 4.5Ω @ V _{GS} = 1.5V | 0.24A |

Description

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch

Features and Benefits

- Low Package Profile, 0.4mm Maximum Package Height
- 0.62mm x 0.62mm Package Footprint
- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V Max
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN31D5UFZQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

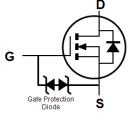
Mechanical Data

- Case: X2-DFN0606-3
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)

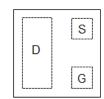








Equivalent Circuit



Top View Package Pin Configuration

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|----------------|--------------|-----------------|
| DMN31D5UFZQ-7B | X2-DFN0606-3 | 10K/Tape & Reel |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Top View Bar Denotes Gate and Source Side

BP = Product Type Marking Code



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|--|-----------------|--|------|--------------|---|
| Drain-Source Voltage | | | VDSS | 30 | V |
| Gate-Source Voltage | Vgss | ±12 | V | | |
| Continuous Drain Current (Note 5) V _{GS} = 4.5V | Steady State | $T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$ | lo | 0.41 0.33 | А |
| Pulsed Drain Current (Note 6) | | | Ірм | 0.7 | Α |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|--|--------------|----------------|------|---|
| Total Power Dissipation (Note 5) | Steady State | P _D | 0.4 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Reja | 315 | °C/W | |
| Operating and Storage Temperature Range | TJ, TSTG | -55 to +150 | °C | |

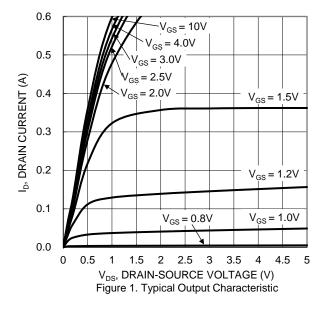
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|--|---------------------|-----|------|-----|------|--|
| OFF CHARACTERISTICS (Note 7) | | • | | | | | • |
| Drain-Source Breakdown Voltage | | BV _{DSS} | 30 | _ | _ | V | $V_{GS} = 0V, I_{D} = 250\mu A$ |
| Zero Gate Voltage Drain Current $T_C = +25^{\circ}C$ | | IDSS | | _ | 100 | nA | V _{DS} = 24V, V _{GS} = 0V |
| Gate-Source Leakage | | Igss | _ | _ | ±10 | μA | $V_{GS} = \pm 10V$, $V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | | V _{GS(TH)} | 0.4 | 1 | 1.0 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ |
| | | | _ | 1.3 | 1.5 | | Vgs = 4.5V, ID = 100mA |
| Statio Drain Source On Begintenes | | D | _ | 1.6 | 2.0 | | $V_{GS} = 2.5V, I_D = 50mA$ |
| Static Drain-Source On-Resistance | | RDS(ON) | _ | 1.8 | 3.0 | Ω | $V_{GS} = 1.8V, I_D = 20mA$ |
| | | | _ | 2.0 | 4.5 | | $V_{GS} = 1.5V, I_D = 10mA$ |
| Diode Forward Voltage | | VsD | _ | 0.54 | 1.0 | V | V _{GS} = 0V, I _S = 10mA |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | | Ciss | _ | 22.6 | _ | pF | |
| Output Capacitance | | Coss | _ | 2.68 | _ | pF | $V_{DS} = 15V, V_{GS} = 0V,$ - f = 1.0MHz |
| everse Transfer Capacitance | | Crss | _ | 1.8 | | pF | 1 - 1.000112 |
| Total Gate Charge | | Qg | _ | 0.38 | _ | nC | |
| Gate-Source Charge | | Qgs | _ | 0.05 | _ | nC | $V_{GS} = 4.5V, V_{DS} = 15V,$ $I_{D} = 200 \text{mA}$ |
| Gate-Drain Charge | | Qgd | _ | 0.07 | _ | nC | TID = ZUUITIA |
| Turn-On Delay Time | | td(ON) | _ | 3.2 | _ | ns | |
| Turn-On Rise Time | | t _R | _ | 2.2 | _ | ns | $V_{DD} = 15V, V_{GS} = 4.5V,$ |
| Turn-Off Delay Time | | t _{D(OFF)} | _ | 21 | _ | ns | $R_G = 2\Omega$, $I_D = 200mA$ |
| Turn-Off Fall Time | | t _F | _ | 7.5 | _ | ns |] |

Notes

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





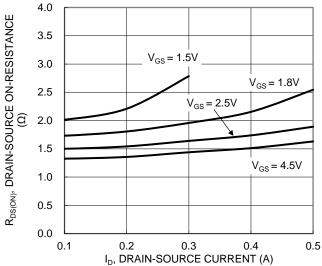


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

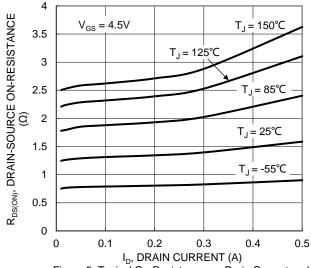
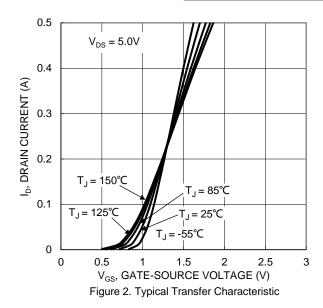
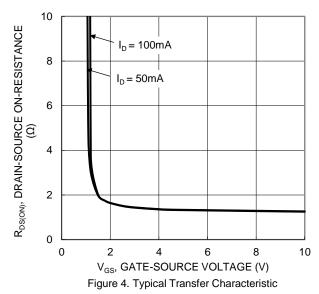


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





2.5 R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) $V_{GS} = 2.5V, I_{D} = 50mA$ 2 1.5 $V_{GS} = 4.5V, I_D = 100mA$ 1 0.5 0 -50 25 50 75 100 125 T_J, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Temperature





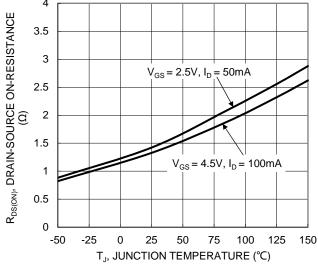


Figure 7. On-Resistance Variation with Temperature

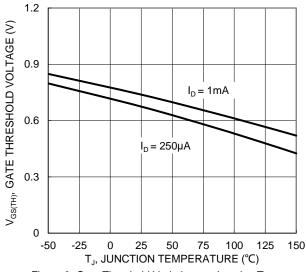


Figure 8. Gate Threshold Variation vs. Junction Temperature

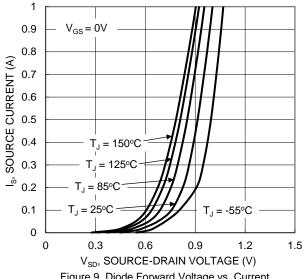
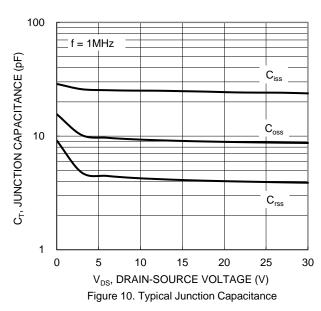


Figure 9. Diode Forward Voltage vs. Current

 $V_{DS} = 15V, I_{D} = 200mA$

0.2



ID, DRAIN CURRENT (A) 0.1 0.01

 Q_g (nC) Figure 11. Gate Charge

0.3

0.4

0.5

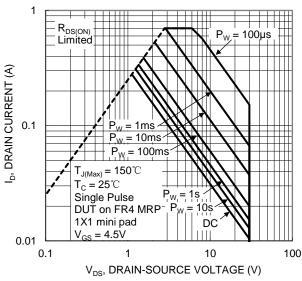


Figure 12. SOA, Safe Operation Area

10

9 8

7

6

5

4

3

2

1

0

0

0.1

 $V_{GS}(V)$

0.6



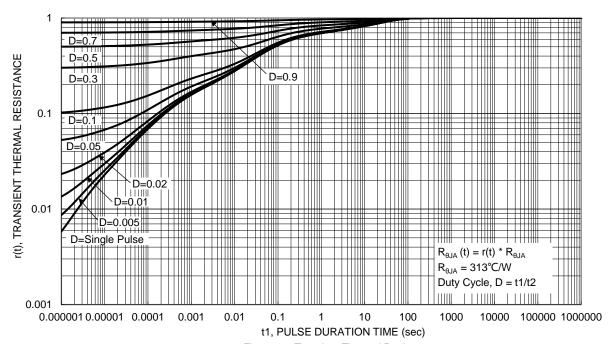


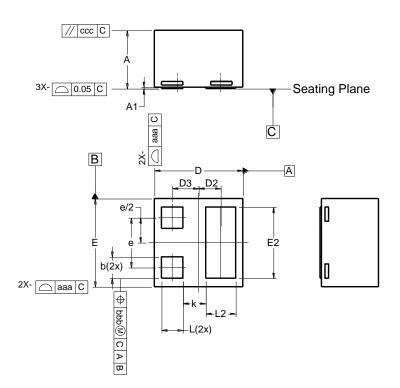
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0606-3

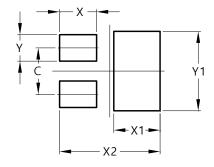


| X2-DFN0606-3 | | | | | |
|----------------------|-----------|-----------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.36 | 0.40 | 0.39 | | |
| A1 | 0.00 | 0.05 | 0.02 | | |
| b | 0.10 | 0.20 | 0.15 | | |
| D | 0.57 | 0.67 | 0.62 | | |
| D2 | 0.155 BSC | | | | |
| D3 | 0.185 BSC | | | | |
| Е | 0.57 | 0.57 0.67 | | | |
| E2 | 0.40 | 0.60 | 0.50 | | |
| е | 0.35 BSC | | | | |
| k | 0.16 REF | | | | |
| L | 0.10 | 0.20 | 0.15 | | |
| L2 | 0.11 | 0.31 | 0.21 | | |
| aaa | 0.08 | | | | |
| bbb | 0.07 | | | | |
| CCC | 0.05 | | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0606-3



| Dimensions | Value (in mm) | | |
|------------|------------------|--|--|
| С | 0.350 | | |
| X | 0.280 | | |
| X1 | 0.350 | | |
| X2 | 0.760 | | |
| Υ | 0.200 | | |
| Y1 | 0.600 | | |



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